

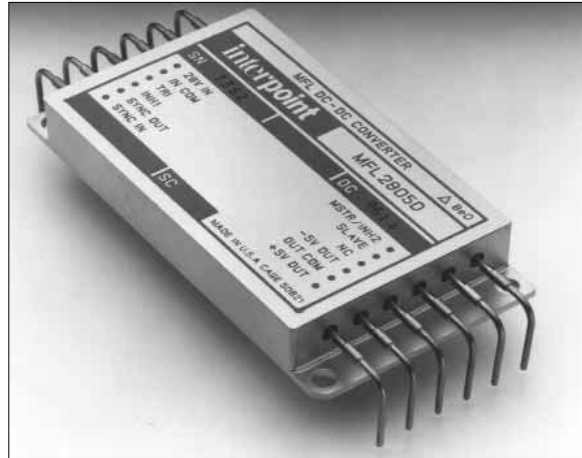
FEATURES

- Adapts Interpoint "U1" cases to upleaded or downleaded configurations
- For use with MFL, MFLHP, MHP, FMD270, HUM-70, or LCM Series of Interpoint products
- Low resistance
- Copper alloy with solder plating over nickel

ACCESSORY PIN TERMINAL ADAPTOR

PIN ADAPTOR

MODEL PIN-001



PIN-001 adaptor dimensions are on the following page.

DESCRIPTION

Interpoint's side-leaded packages can now be adapted with PIN terminal adapters to fit a variety of configurations. These versatile adapters slide over the ends of side-leaded package terminals and are intended to be soldered to the leads to provide an up-leaded or down-leaded configuration.

CONSTRUCTION

PIN adapters are constructed from low resistance copper alloy Cu-70210 which has a conductivity similar to that of copper. The plating is 50 microinches (0.12mm) of solder — 60% tin and 40% lead — over 100 to 200 microinches (2.5 to 5mm) of electrolytic nickel plating.

LOW RESISTANCE

Low resistance copper alloy construction minimizes the voltage drop across the PIN terminals. For example, when operating the MFL2805S at full load (10 A) the voltage drop over the full length of the adapter on positive V_{out} is just 30 mV. On single output converter models, the sense function can compensate for even this small drop if required.

SOLDERING

To prevent unwanted solder reflow, Interpoint suggests the use of SN 96 (high-temp solder) to connect the PIN to the converter terminal and SN 62 to connect the PIN to the board. The soldering restrictions referenced on the data sheets of the listed Interpoint products are 300°C for a maximum of 10 seconds per terminal.

APPLICATION

PIN terminal adapters are compatible with the following Interpoint products:

- MFL Series DC/DC converters
- MFLHP Series DC/DC converters
- MHP Series DC/DC converters
- FMD-461SL, side-leaded DC/DC converter
- LCM Line Conditioning Module
- HUM-70 Hold-Up Module

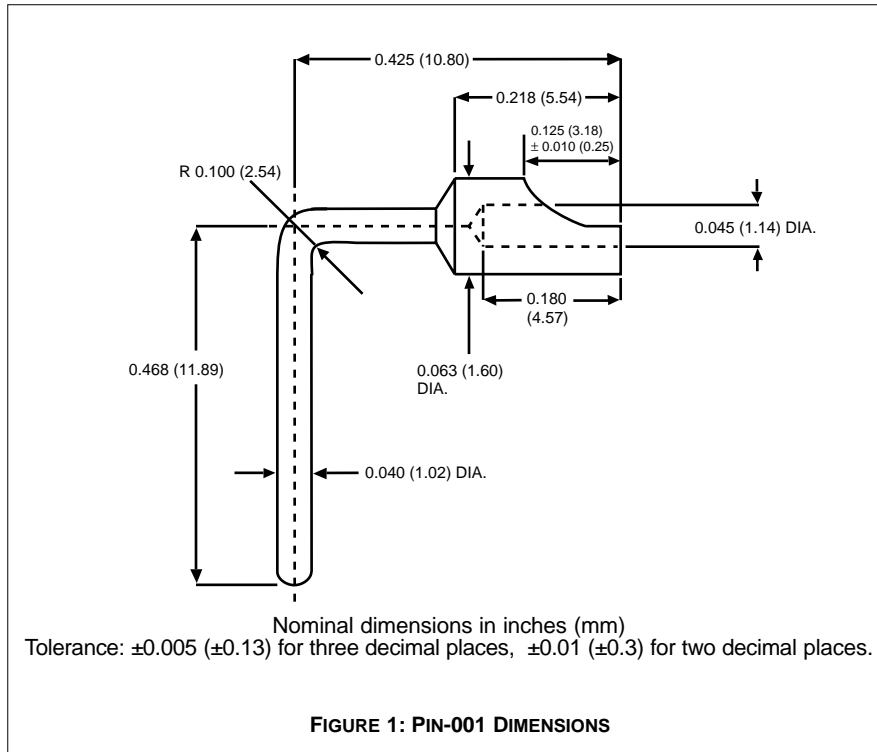
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**PIN
ADAPTOR**

**ACCESSORY
TERMINAL ADAPTOR**



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PIN adaptors are designed to be used with case U1 (see Section B8).